

# Infrared Remote-Control Receiver Module

Technical Data Sheet

Part No.: LL-M6038



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Approved: ZHOU Checked: Wu Drawn: Shu



#### Features:

- Photo detector and preamplifier in one package.
- Photodiode with integrated circuit.
- ⋄ Internal filter for PCM frequency.
- Improved shielding against electrical field disturbance.
- ♦ High protection ability against EMI.
- High immunity against ambient light.
- High sensitivity.
- Low voltage and low power consumption.
- Long reception distance.
- Circular lens to improve the receive characteristic.
- ♦ TTL and CMOS compatibility.
- Output active low.
- Line-up for various center carrier frequencies.
- ♦ The product itself will remain within RoHS compliant version.

## Descriptions:

- The M6038 series are miniaturized receivers for infrared remote control systems. PIN diode and preamplifier are assembled on lead frame, the epoxy package is designed as IR filter. The demodulated output signal can directly be decoded by a microprocessor. The benefit is the reliable function even in disturbed ambient and the protection against uncontrolled output pulses.
- ♦ The M6038 series is the standard IR remote control receiver series, supporting all major transmission codes.

## Applications:

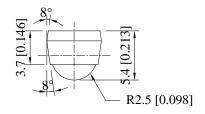
- Optical switch.
- Light detecting portion of remote control.
- ♦ AV instruments such as Audio, TV, VCR, CD, MD, etc.
- ♦ Home appliances such as Air-conditioner, Fan, etc.
- ⋄ The other equipments with wireless remote control.
- ◇ CATV set top boxes.
- Multi-media Equipment.

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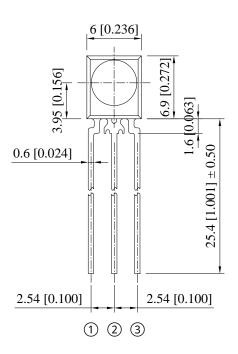
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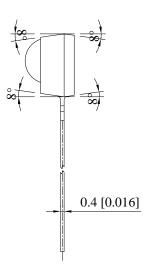


# Package Dimension:



- ① Vout
- ② GND
- 3 Vcc





Part No.	Material		Color	Source Color
LL-M6038	Chip	Silicon		Infrared Receiver
	Lead Frame	SPCC	Silver White	
	Compound	Epoxy	Black	

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25mm (.010") unless otherwise specified.
- 3. Specifications are subject to change without notice.

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# Absolute Maximum Ratings at Ta=25℃

Parameters	Symbol	Value	Unit	Condition
Power Dissipation	PD	50	mW	Ta≤85°C
Supply Voltage	$V_{CC}$	-0.30 ~ +6.00	V	Pin1
Operating Current	$I_{C}$	3.00	mA	Pin1
Collector-Emitter Voltage	$V_{CEO}$	30	V	
Emitter-Collector-Voltage	V <sub>ECO</sub>	5	V	
Operating Temperature	T <sub>OPR</sub>	-25 ~ +85	°C	
Storage Temperature	T <sub>STG</sub>	-40 ~ +100	$^{\circ}$	
Soldering Temperature [4mm (.157") from mold body]	T <sub>SOL</sub>	260	°C	t≤10s

# Electrical Optical Characteristics at (Ta=25°C, Vcc=5V, f0=38KHz)

Parameters	Symbol	Min.	Туре	Max.	Unit	Coi	ndition	
Power Supply Voltage	V <sub>CC</sub>	2.70	5.00	5.50	V			
Dissipation Current	$I_{CC}$		1.00	1.50	mA	V <sub>CC</sub> =5V, Ev=0		
Static State Current	$\mathbf{I}_CE$			0.50	mA	No Signal Input		
Collector Dark Current	$I_{CEO}$			100	nA	V <sub>CE</sub> =20V, Ee=0mW/cm <sup>2</sup>		
Reception Angle *	2θ <sub>1/2</sub>		90		Deg			
Peak Wavelength	λр		940		nm			
Modulated Frequency	$f_0$		38		KHz			
Max. Voltage Gain	Av	75	80	85	dB	F <sub>IN</sub> =37.9kHz V <sub>IN</sub> =30µV p-p KHz		
BPF Bandwidth	$f_{BW}$	f <sub>0</sub> -1.5	$f_0$	f <sub>0</sub> +1.5	KHz	-3Db Bandwidth		
	L <sub>0</sub>	14			m	0°	V <sub>CC</sub> =5V,	
Reception Distance	L <sub>1</sub>	12			m	30°	At the ray axis	
	L <sub>2</sub>	10			m	45°	(Note 1)	
Low Level Output Voltage	V <sub>OL</sub>			0.25	V	Ev=0.5mw/m <sup>2</sup> (Cycle=1.2ms) (Duty=50%)		
High Level Output Voltage	V <sub>OH</sub>	V <sub>CC</sub> - 0.25		V <sub>CC</sub>	V			
Low Output Pulse Width	T <sub>PWL</sub>	300	600	900	μs	V <sub>IN</sub> =50mVp-p		
High Output Pulse Width	T <sub>PWH</sub>	300	600	900	μs	V <sub>IN</sub> =	50mVp-p	

#### Notes:

1. The ray receiving surface at a vertex and relation to the ray axis in the range of  $\theta$ =0° and  $\theta$ =45°.

2. A range from 30cm to the arrival distance. Average value of 50 pulses.

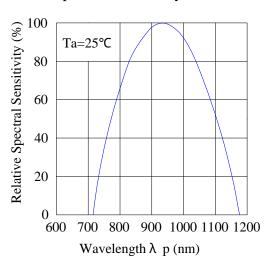
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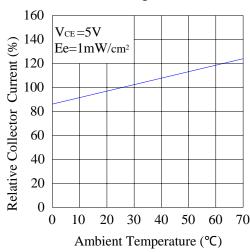


# Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

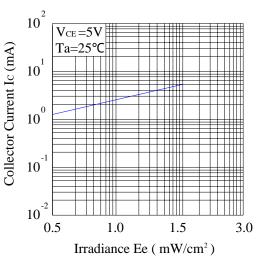
### Spectral Sensitivity



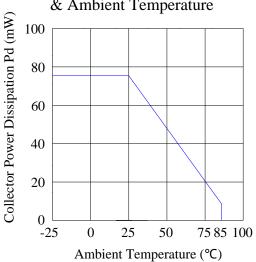
# Relative Collector Current & Ambient Temperature



### Collector Current & Irradiance



# Collector Power Dissipation & Ambient Temperature



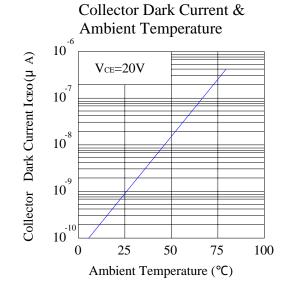
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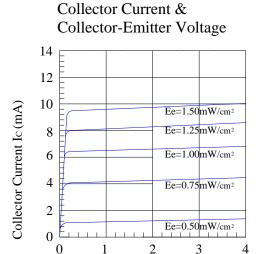
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Lucky Light Electronics Co., Ltd.

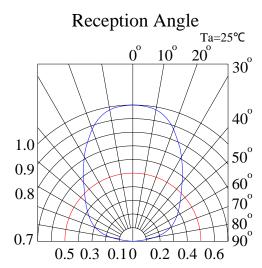
http://www.luckylight.cn







Collector-Emitter Voltage VCE (V)

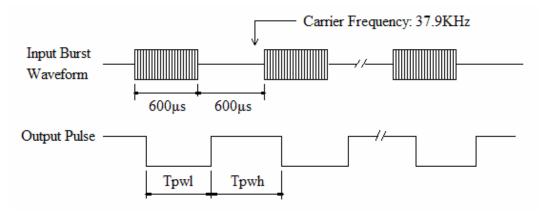


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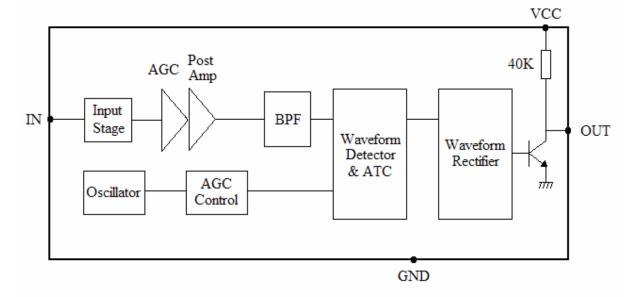
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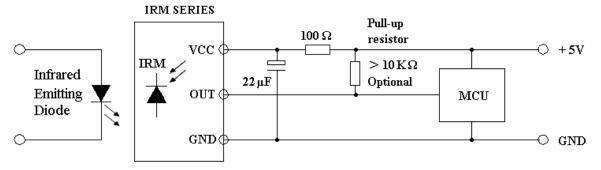
## The test waveform:



## Electrical truth chart:



## Applications:



RC Filter should be connected closely between Vcc pin and GND pin.

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#### Test Method:

The specified electro-optical characteristics is satisfied under the following conditions at the controllable distance.

① Measurement place.

A place that is nothing of extreme light reflected in the room.

② External light.

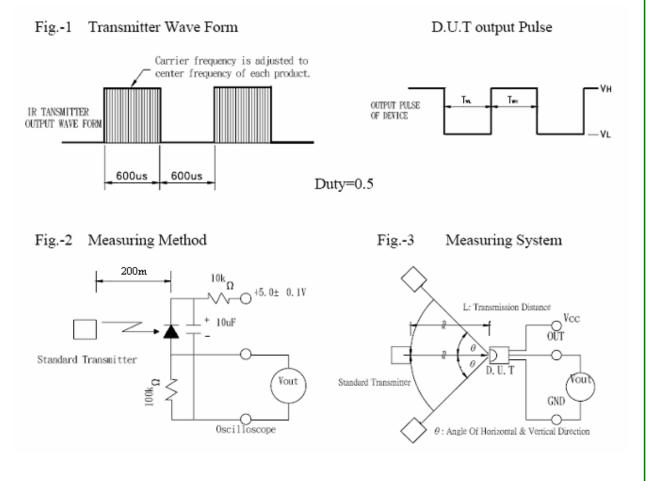
Project the light of ordinary white fluorescent lamps which are not high frequency lamps and must be less then 10Lux at the module surface ( $Ee \le 10Lux$ ).

3 Standard transmitter

A transmitter whose output is so adjusted as to Vo=400mVp-p and the output wave form shown in Fig.-1.According to the measurement method shown in Fig.-2 the standard transmitter is specified. However, the infrared photodiode to be used for the transmitter should be  $\lambda p=940$ nm,  $\Delta \lambda=50$ nm. Also, photodiode is used of PD516AD (V<sub>R</sub>=5V). (Standard light / Light source temperature 2856°K).

4 Measuring system.

According to the measuring system shown in Fig.-3.



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# Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%.

LTPD: 10%.

No.	Test Items	Test Conditions	Failure Judgment Criteria	Samples(n) Defective(c)
1	Temperature Cycle	1 cycle -25°C ∫ +85°C (30min) (5min) (30min) 300 cycle test		n=22, c=0
2	High Temperature Test	Temp: +85°C Vcc: 5V 1000hrs	L0 ≦ L×0.8 L45 ≦ L×0.8	n=22, c=0
3	Low Temperature Storage	Temp: -25℃ 1000hrs	L: Lower	n=22, c=0
4	High Temperature High Humidity	Ta: 85℃, RH:85% 1000hrs	Specification Limit	n=22, c=0
5	Solder Heat	Temp: 260±5°C 10sec 4mm From the bottom of the package.		n=22, c=0

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## Please read the following notes before using the product:

### 1. Over-current-proof

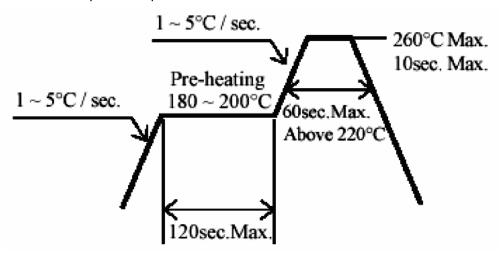
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the Infrared Receiver Module should be kept at 30°C or less and 90%RH or less.
  - 2.3 The Infrared Receiver Module should be used within a year.
- 2.4 After opening the package, the Infrared Receiver Module should be kept at 30°C or less and 70%RH or less.
- 2.5 The Infrared Receiver Module should be used within 168 hours (7 days) after opening the package.
  - 2.6 If the moisture adsorbent material (silica gel) has fabled away or the Infrared Receiver Module have exceeded the storage time, baking treatment should be performed using the following conditions: Baking treatment: 60±5°C for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile.



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the Infrared Receiver Module during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

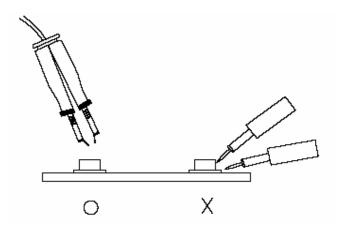
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## 5. Repairing

Repair should not be done after the Infrared Receiver Module have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the Infrared Receiver Module will or will not be damaged by repairing.



#### 6. Caution in ESD

Static Electricity and surge damages the Infrared Receiver Module. It is recommended to use a wrist band or anti-electrostatic glove when handling the Infrared Receiver Module. All devices, equipment and machinery must be properly grounded.

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